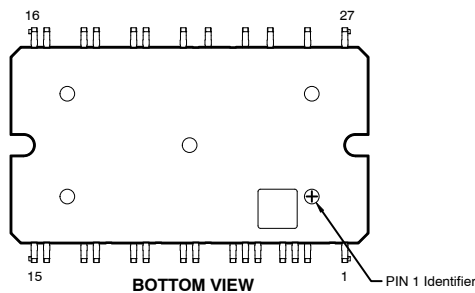
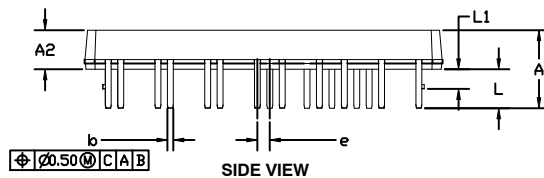
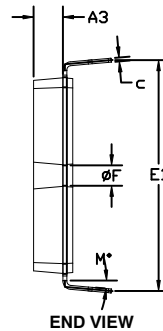
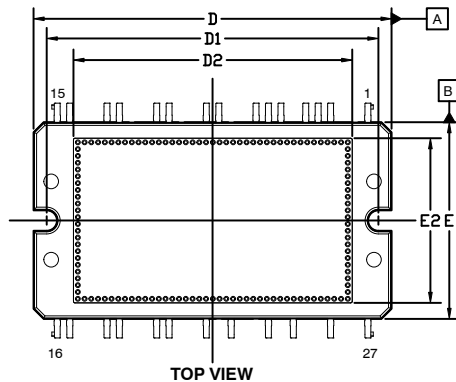
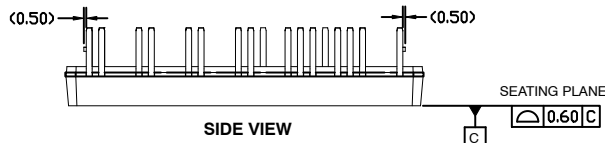

**DIP27 73.2x40.2**  
**CASE 184AA**  
**ISSUE B**

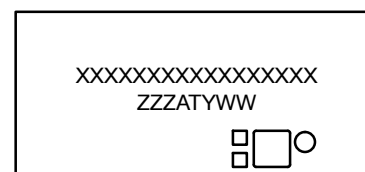
DATE 15 JUL 2021



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	15.50	16.00	16.50
A2	7.80	8.00	8.20
A3	6.00 REF		
b	1.10	1.20	1.30
c	0.70	0.80	0.90
D	72.70	73.20	73.70
D1	67.30	67.80	68.30
D2	57.30 REF		
E	39.70	40.20	40.70
E1	46.70	47.20	47.70
E2	33.87 REF		
e	2.54 BSC		
F	4.00	4.20	4.40
L	8.00 REF		
L1	3.50	4.00	4.50
M	4°	5°	6°

**NOTES:**

- 1.Dimensioning and tolerancing as per ASME Y14.5M, 2009
- 2.Controlling Dimension: Millimeters
- 3.Dimensions are exclusive of Burrs, Mold Flash, and Tiebar extrusions
- 4.Dimensions "b" and "c" apply to plated leads
- 5.Position of the leads is determine at the root of the lead where it exits the package body

**GENERIC MARKING DIAGRAM\***


XXX = Specific Device Code  
 ZZZ = Assembly Lot Code  
 A = Assembly Site  
 T = Test Site  
 Y = Year  
 WW = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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<b>DESCRIPTION:</b>	<b>DIP27 73.2x40.2</b>	<b>PAGE 1 OF 1</b>

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